查询TIC201供应商

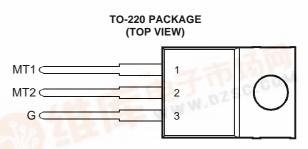
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TIC201 SERIES SILICON TRIACS

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JANUARY 1977 - REVISED MARCH 1997

- Sensitive Gate Triacs
- 2.5 A RMS
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I_{GT} of 5 mA (Quadrant 1)



Pin 2 is in electrical contact with the mounting base.

MDC2ACA

absolute maximum ratings over operating case temperature (unless otherwise noted)

| RATING | | | VALUE | |
|---|---------|------------------|-------------|----|
| | TIC201D | | 400 | 1 |
| Repetitive peak off-state voltage (see Note 1) | TIC201M | V _{DRM} | 600 | V |
| | TIC201S | * DRM | 700 | v |
| | TIC201N | | 800 | |
| Full-cycle RMS on-state current at (or below) 85°C case temperature (see Note 2) | | | 2.5 | A |
| Peak on-state surge current full-sine-wave (see Note 3) | | | 12 | A |
| Peak on-state surge current half-sine-wave (see Note 4) | | | 14 | A |
| Peak gate current | | | ±0.2 | A |
| Peak gate power dissipation at (or below) 85°C case temperature (pulse width \leq 200 µs) | | | 1.3 | W |
| Average gate power dissipation at (or below) 85°C case temperature (see Note 5) | | | 0.3 | W |
| Operating case temperature range | | | -40 to +110 | °C |
| Storage temperature range | | | -40 to +125 | °C |
| Lead temperature 1.6 mm from case for 10 seconds | | T | 230 | °C |

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 85°C derate linearly to 110°C case temperature at the rate of 100 mA/°C.

3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.

4. This value applies for one 50-Hz half-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.

5. This value applies for a maximum averaging time of 20 ms.

with the terms of Power Innovations standard warranty. Production processing does not

electrical characteristics at 25°C case temperature (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | | MIN | ТҮР | MAX | UNIT |
|------------------|--------------------------------------|------------------------------|-----------------------|---------------------------|-------|------|------|-------|
| I _{DRM} | Repetitive peak off-state current | V_D = rated V_{DRM} | $I_{\rm G} = 0$ | T _C = 110°C | RE-J | -TP | C±10 | mA |
| I _{GTM} | | V _{supply} = +12 V† | R _L = 10 Ω | t _{p(g)} > 20 μs | W W Y | | 5 | -8 mA |
| | Peak gate trigger | V _{supply} = +12 V† | R _L = 10 Ω | t _{p(g)} > 20 μs | | | -8 | |
| | current | V _{supply} = -12 V† | R _L = 10 Ω | t _{p(g)} > 20 μs | | | -10 | |
| | | V _{supply} = -12 V† | R _L = 10 Ω | t _{p(g)} > 20 μs | | | 25 | |
| V _{GTM} | | V _{supply} = +12 V† | $R_L = 10 \Omega$ | t _{p(g)} > 20 μs | | 0.9 | 2.5 | V |
| | Peak gate trigger | V _{supply} = +12 V† | $R_L = 10 \Omega$ | t _{p(g)} > 20 μs | | -1.2 | -2.5 | |
| | voltage | V _{supply} = -12 V† | $R_L = 10 \ \Omega$ | t _{p(g)} > 20 μs | | -1.2 | -2.5 | |
| | | V _{supply} = -12 V† | $R_L = 10 \ \Omega$ | t _{p(g)} > 20 μs | | 1.2 | | |

† All voltages are with respect to Main Terminal 1.



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TIC201 SERIES SILICON TRIACS

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electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

| PARAMETER | | TEST CONDITIONS | | | MIN | ТҮР | МАХ | UNIT |
|----------------------|--------------------------|---|---------------------------|----------------------------------|-----|-----|------|------|
| V _{TM} | Peak on-state voltage | I _{TM} = ±3.5 A | l _G = 50 mA | (see Note 6) | | | ±1.9 | V |
| I _H | Holding current | V _{supply} = +12 V† | $I_{G} = 0$ | Init' I _{TM} = 100 mA | | | 30 | mA |
| | | $V_{supply} = -12 V^{+}$ | $I_{G} = 0$ | Init' I _{TM} = - 100 mA | | | -30 | |
| IL | Latching current | V _{supply} = +12 V† | (see Note 7) | | | | 40 | mA |
| | | $V_{supply} = -12 V^{+}$ | | | | | -40 | ШA |
| dv/dt | Critical rate of rise of | V_{DRM} = Rated V_{DRM} | $I_{\rm G} = 0$ | T _C = 110°C | | ±50 | | V/µs |
| | off-state voltage | | | | | ±30 | | v/µs |
| du/dt | Critical rise of | V _{DRM} = Rated V _{DRM} | I _{TRM} = ±3.5 A | T _C = 85°C | ±2 | | | V/µs |
| dv/dt _(c) | commutation voltage | | | | | | | v/µs |

† All voltages are with respect to Main Terminal 1.

NOTES: 6. This parameter must be measured using pulse techniques, $t_p = \le 1$ ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

7. The triacs are triggered by a 15-V (open circuit amplitude) pulse supplied by a generator with the following characteristics: $R_G = 100 \Omega$, $t_{p(g)} = 20 \mu s$, $t_r = \le 15 ns$, f = 1 kHz.

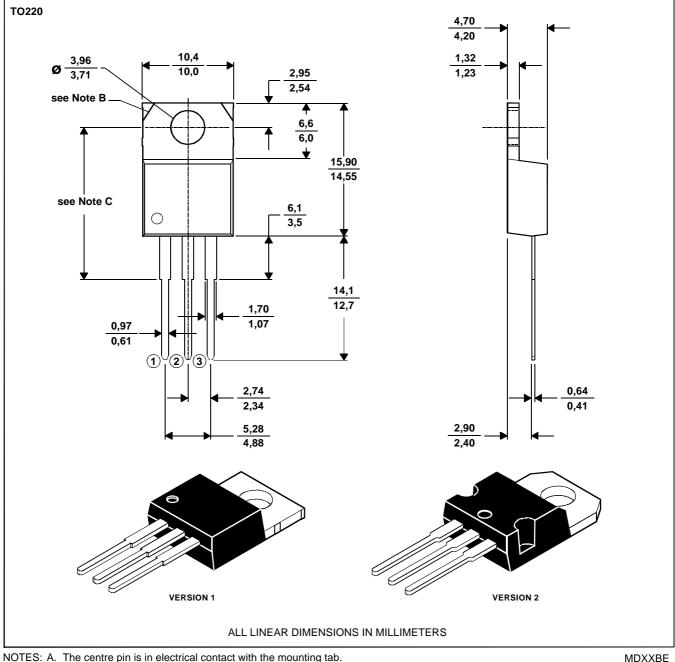
thermal characteristics

| PARAMETER | | | TYP | MAX | UNIT |
|-----------------|---|--|-----|------|------|
| R_{\thetaJC} | Junction to case thermal resistance | | | 10 | °C/W |
| $R_{\theta JA}$ | Junction to free air thermal resistance | | | 62.5 | °C/W |

MECHANICAL DATA

TO-220 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



- - B. Mounting tab corner profile according to package version.
 - C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm.

MDXXBE



PRODUCT INFORMATION

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